

<b>PATENT ASSIGNMENT COVER SHEET</b>
--------------------------------------

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT7098901

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT OF PATENT OWNERSHIP OF SIARGO LTD. TO SIARGO, INC. M-TECH INSTRUMENT CORPORATION (HOLDING) LIMITED STILL KEEP IT'S 50% RIGHTS OF THE WHOLE PATENT OWNERSHIP.
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SIARGO LTD.	12/30/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SIARGO, INC.
<b>Street Address:</b>	3100 DE LA CRUZ BLVD. SUITE 210
<b>City:</b>	SANTA CLARA
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95054
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	7752910
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(408)969-0368
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	4088198917
<b>Email:</b>	cchen@siargo.com
<b>Correspondent Name:</b>	CHIH-CHANG CHEN
<b>Address Line 1:</b>	3100 DE LA CRUZ BLVD. SUITE 210
<b>Address Line 4:</b>	SANTA CLARA, CALIFORNIA 95054
<b>NAME OF SUBMITTER:</b>	CHIH-CHANG CHEN
<b>SIGNATURE:</b>	/Chih-Chang Chen/
<b>DATE SIGNED:</b>	12/30/2021
<b>Total Attachments: 2</b>	
source=ASSIGNMEN_Micromachined_mass_flow_sensor_and_methods_of_the_same_12_29_2021#page1.tif	
source=ASSIGNMEN_Micromachined_mass_flow_sensor_and_methods_of_the_same_12_29_2021#page2.tif	

# UTILITY PATENT ASSIGNMENT

FOR VALUE RECEIVED, the receipt of which is hereby acknowledged, the following entity (hereinafter called "ASSIGNOR")

Name: **Siargo Ltd.**

Address: 3100 De La Cruz Boulevard, Suite 210, Santa Clara, CA 95054, USA

hereby agrees to transfer and assign its rights and interest in the patent to:

Name: **Siargo, Inc.**

Address: 3100 De La Cruz Boulevard, Suite 210, Santa Clara, CA 95054, USA

(hereinafter called "ASSIGNEE"), the entire worldwide right, title and interest in and to the invention known as:

for which a United States Patent was filed on even date herewith or, if not so, was

filed on April 3, 2008

Patent No. 7752910

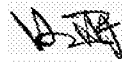
**Tilte: MICROMACHINED MASS FLOW SENSOR AND METHODS OF MAKING THE  
SAME**

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, to sue for past infringement.

(1) The ASSIGNOR agrees without charge to said ASSIGNEE but at its expense (a) to execute (i) all necessary papers to be used in connection with this application and any additional, continuing, or divisional applications, as the ASSIGNEE may deem necessary or expedient, (ii) all papers in connection with any interference or other legal or quasi-legal proceedings relating to this application or any additional, continuing, or divisional application thereof; (b) to cooperate with ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and (c) to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said invention.

(2) ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States to issue any and all Letters Patent that may be granted upon any patent application or any additional, continuing or divisional applications thereof to the ASSIGNEE, its successors and assigns.

(3) ASSIGNOR hereby covenants and warrants that he has full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

A handwritten signature in black ink, appearing to be "B. J. B.", is positioned above the signature line.

Date Dec. 30, 2021      Signature \_\_\_\_\_